

# UTAC Places Order For Multiple Teradyne Tiger For High-performance SOC Test Solutions

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UTAC to be the first subcontractor in Asia to offer such advanced mixed-signal testing capability to its customers

Singapore, July 11, 2000 - United Test and Assembly Center Limited ("UTAC") announced today it has selected and placed orders for multiple Catalyst Tiger systems for testing high performance system-on-chip (SOC) devices. The new test instrument is an extension to UTAC SOC tester family. The Catalyst Tiger has 1024 digital pins, integrated analog capabilities and full I/O data rates to 1.6 Gbps.

Teradyne brings together the successful Catalyst parallel processing architecture and integrated analog instrumentation with new high speed digital, scan and memory test in the Tiger systems. The flexibility of Tiger allows customers to configure their system to meet the test requirements of a broad range of devices. Whether testing high performance network processor or multi-site communications and disk drive devices, Tiger has digital speed from 300 MHz to 1.6 GHz and analog instrumentation from audio to microwave combined in high throughput architecture.

"We view the selection of Tiger as an investment in our capabilities that enables us to expand and meet our customer's needs. In addition to excellent test performance, Tiger's capabilities are a catalyst for UTAC winning key customers in the broadband communications market. UTAC's partnership with Teradyne better positions us to support our growing customer base and the growing test demands of the high-performance SOC." said Chok Yean Hung, vice president, product and test engineering of UTAC.

"We are being qualified by world-leading companies in communication and computer peripheral ICs and to use the Tiger for SOC products such as disk drive, network switching, PC chip set and advanced graphic applications." said Albert Ng, vice president, sales and marketing of UTAC. "With addition of Tiger, we are even better positioned to support our growing customers base in the high-performance SOC arena."

## About United Test and Assembly Center Ltd (UTAC)

United Test and Assembly Center Ltd. (UTAC), founded on 16th March 1998, is a QS9000/ISO9001/SAC certified semiconductor assembly and test services provider. We offer full turnkey services from wafer sort / laser repair, packaging, Test / Burn in, Mark-Scan-Pack and drop shipment services. In addition, we provide customers with value-added services in package design and simulation, test program development and device characterization, failure analysis services and full reliability test services.

UTAC is committed to provide customers one-stop turnkey semiconductor assembly and testing services for wide spectrum of memory, logic and mixed signal devices.

UTAC World Wide Web address is <http://www.utac.com.sg/>.